

NCV7691

Current Controller for Automotive LED Lamps

The NCV7691 is a device which uses an external NPN bipolar device combined with feedback resistor(s) to regulate a current for use in driving LEDs. The target application for this device is automotive rear combination lamps. A single driver gives the user flexibility to add single channels to multichannel systems. A dedicated dimming feature is included via the PWM input pin. The individual driver is turned off when an open load or short circuit is detected.

LED brightness levels are easily programmed using an external resistor in series with the bipolar transistor. The use of the resistor gives the user the flexibility to use the device over a wide range of currents.

Multiple strings of LEDs can be operated with a single NCV7691 device.

Set back power limit reduces the drive current during overvoltage conditions.

The device is available in a SOIC–8 package.

Features

- Constant Current Output for LED String Drive
- External Bipolar Device for Wide Current Range Flexibility
 - ♦ With BCP56 Transistor, Can Drive Multiple Strings Concurrently (ref. Datasheet Info)
- External Programming Current Resistor
- Pulse Width Modulation (PWM) Control
- Negative Temperature Coefficient Current Control Option
- Open LED String Diagnostic
- Short–Circuit LED String Diagnostic
- Multiple LED String Control
- Overvoltage Set Back Power Limitation
- SOIC–8 Package
- AEC–Q100 Qualified and PPAP Capable
- These are Pb–Free Devices

Applications

- Rear Combination Lamps (RCL)
- Daytime Running Lights (DRL)
- Fog Lights
- Center High Mounted Stop Lamps (CHMSL) Arrays
- Turn Signal and Other Externally Modulated Applications
- General Automotive Linear Current LED Driver



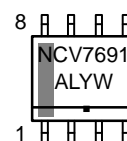
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**SOIC 8
CASE 751AZ**

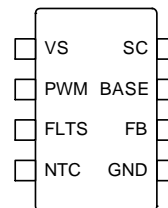
MARKING DIAGRAM



IC (Pb–Free)

NCV7691 = Specific Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb–Free Package

PINOUT DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping†
NCV7691D10R2G	SOIC–8 (Pb–Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NCV7691

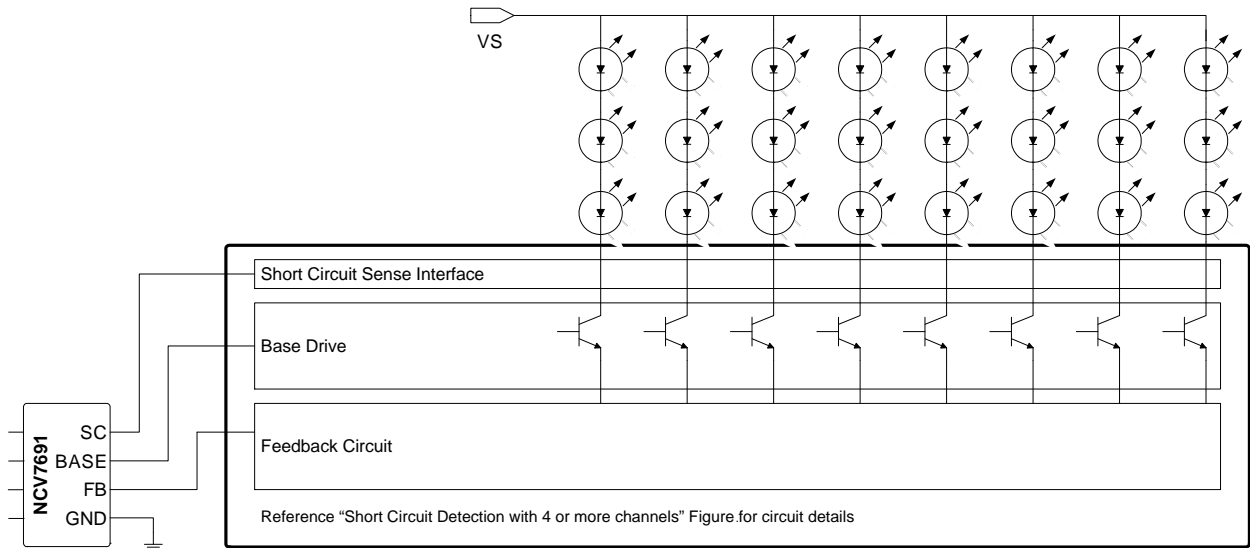


Figure 1. Application Diagram

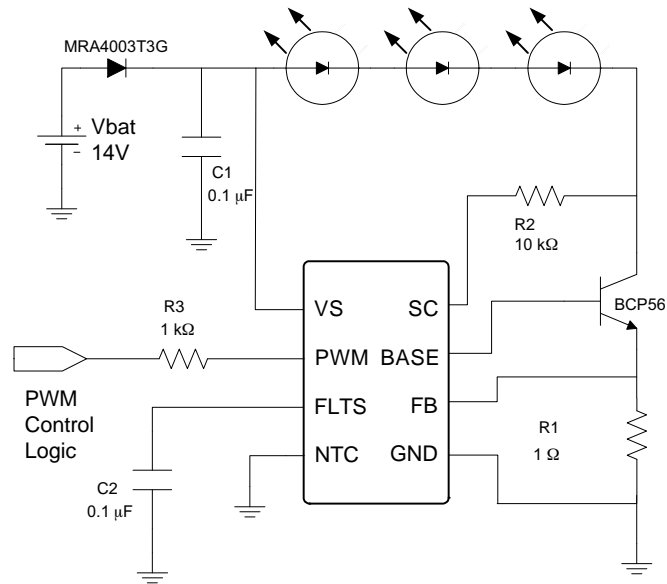


Figure 2. Microprocessor Controlled Application Diagram

NCV7691

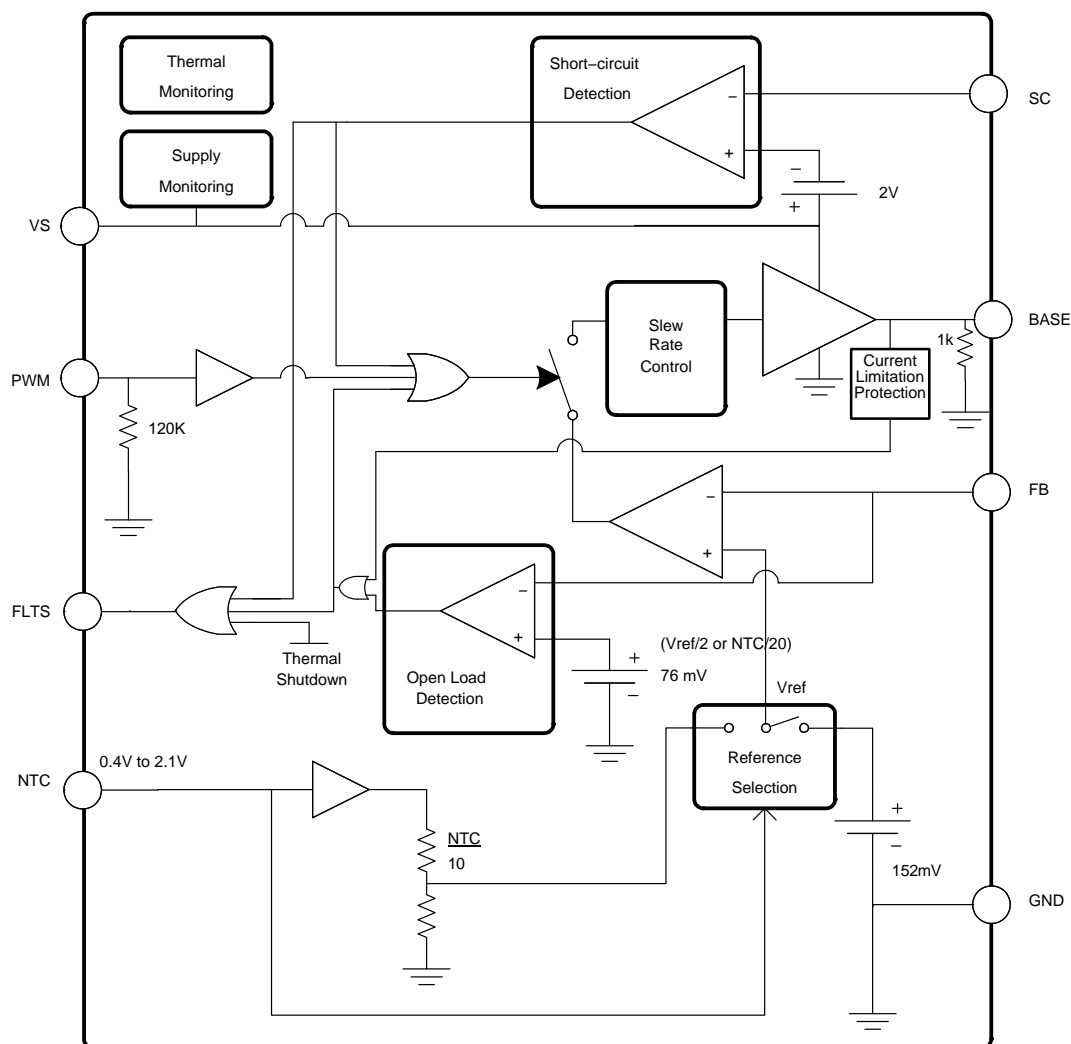


Figure 3. Block Diagram

PIN FUNCTION DESCRIPTION

8 Lead SON Package		
Pin #	Label	Description
1	VS	Automotive Battery input voltage
2	PWM	Logic input for output on/off control. Pull high for output on.
3	FLTS	A capacitor to ground sets the time for open circuit, short circuit, and overtemperature detection.
4	NTC	Optional input for Negative Temperature Coefficient performance. Ground this pin if Negative Temperature Coefficient is not used.
5	GND	Ground
6	FB	Feedback pin for current regulation
7	BASE	Base Drive for external transistor (14 mA [min])
8	SC	LED Short Circuit Detection Input. Ground pin if not used.

MAXIMUM RATINGS

(Voltages are with respect to GND, unless otherwise specified)

Rating	Value	Unit
Supply Voltage (VS) DC Peak Transient	–0.3 to 50 50	V
High Voltage Pins (PWM, SC)	–0.3 to (VS + 0.3)	V
Low Voltage Pins (FB, NTC)	–0.3 to 3.6	V
Low Voltage Pin (BASE) Referenced to GND Referenced to VS (max)	–0.3 to 3.6 0.6	V
Fault Input / Output (FLTS)	–0.3 to (VS + 0.3) * Internally limited charge voltage	V
Junction Temperature, T _J	–40 to 150	°C
Peak Reflow Soldering Temperature: Pb–Free, 60 to 150 seconds at 217°C (Note 1)	260 peak	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- For additional information, please see or download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D and Application Note AND8003/D.

ATTRIBUTES

Characteristic	Value
ESD Capability Human Body Model Machine Model Charge Device Model	±4.0 kV ≥ ±200 V ≥ ±1 kV
Moisture Sensitivity	MSL2
Storage Temperature	–55 to 150°C
Package Thermal Resistance SOIC–8 Junction–to–Board, R _{ψJB} (Note 2) Junction–to–Ambient, R _{θJA} Junction–to–Lead, R _{ψJL}	129°C/W (preliminary) 179°C/W (preliminary) 100°C/W (preliminary)

- Values represent typical still air steady–state thermal performance on 1 oz. copper FR4 PCB with 650 mm² copper area.

ELECTRICAL CHARACTERISTICS

(4.5 V < VS < 18 V, C_{FLTS} = 0.1 μF, R1 = 1 Ω, Transistor NPN = BCP56, -40°C ≤ T_J ≤ 150°C, unless otherwise specified) (Note 3)

Characteristic	Conditions	Min	Typ	Max	Unit
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General Parameters

Supply Current in normal condition	VS = 14 V, PWM = 0	–	30	100	μA
	VS = 14 V, PWM = High Base current subtracted	–	3.0	4.0	mA
Supply Current in fault condition	VS = 14 V, PWM = High V _{FLTS} ≥ FLTS Clamp (5.0 V typ.)	–	1.8	2.8	mA
Under Voltage Lockout	VS rising	3.5	4.0	4.5	V
Under Voltage Lockout Hysteresis		–	200	–	mV
Thermal Shutdown	(Note 4)	150	170	190	°C
Thermal Hysteresis	(Note 4)	–	15	–	°C
Thermal Shutdown Delay	(Note 4)	10	23	36	μsec

Base Current Drive

Output Source Current	BASE = 1 V, FB = 0 V	16	25	30	mA
Output Pull-Down Resistance	PWM = 0 V, BASE = 1 V, FB = 0 V	0.5	1	2	kΩ
Unity Gain Bandwidth		–	100	–	kHz
Amplifier Trans-conductance		–	30	–	mA/mV

Programming

FB Regulation Voltage	Under Voltage Lockout < VS < Over Voltage Fold Back Threshold 1	142	152	162	mV
	VS > Over Voltage Fold Back Threshold 1	54	76	100	
	VS > Over Voltage Fold Back Threshold 2	22	38	50	
VS Overvoltage Fold Back Threshold 1		18.7	19.5	20.5	V
VS Overvoltage Fold Back Threshold 1 Hysteresis		–	700	–	mV
VS Overvoltage Fold Back Threshold 2		30.3	31.4	32.5	V
VS Overvoltage Fold Back Threshold 2 Hysteresis		–	700	–	mV

Open Load Timing

VS Open Load Disable Threshold	VS falling	8.0	8.5	8.8	V
FLTS Charge Current	PWM = 5 V, FB = 0 V, VS = 14 V	1	2	3	mA
FLTS Pull Down Resistor		400	600	800	kΩ
FLTS Threshold (Output Deactivation Threshold)		1	1.15	1.3	V
FLTS Clamp	VS = 18 V, (Note 7) PWM = 5 V, Charge Current activated Above this clamp voltage Charge current rolls off to 0	4	5	6	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Designed to meet these characteristics over the stated voltage and temperature recommended operating ranges, though may not be 100% parametrically tested in production.
4. Guaranteed by design.
5. NTC = 400 mV is > NTC detection level and is a higher impedance than when operating within the detection level.
6. Evaluated at VS = 14V, (LED string current)_{max} = 15 mA to 37 mA.
7. Device tested at 18 V. Upper limit of 6 V applies across the VS input supply range, but the maximum rating for FLTS (–0.3V to VS to –0.3V) must be considered for all system designs especially at the minimum extreme of VS = 4.5 V.

ELECTRICAL CHARACTERISTICS

(4.5 V < VS < 18 V, C_{FLTS} = 0.1 μF, R1 = 1 Ω, Transistor NPN = BCP56, -40°C ≤ T_J ≤ 150°C, unless otherwise specified) (Note 3)

Characteristic	Conditions	Min	Typ	Max	Unit
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Short Circuit

Short Circuit Detection Threshold		VS - 1.7	VS - 2	VS - 2.3	V
Short Circuit Output Current	Current out of the SC pin	-	8	16	μA

PWM

Input High Threshold		-	-	2.2	V
Input Low Threshold		0.7	-	-	V
Hysteresis		-	0.35	-	V
Input Pull-down Resistor		30	120	190	kΩ

Temperature Compensation

NTC Attenuation	0.4 V < NTC < 2.1 V	-	1/10	-	
Regulation Offset (referenced to FB)	NTC = 1.6 V Typ, 0.4 V < NTC < 2.1 V, VS = 14 V	-2 -7	- -	+2 +7	% mV
NTC Input Pull-down Resistor	NTC = 150 mV (low impedance) NTC = 400 mV (high impedance) (Note 5)	15	22 1	31	kΩ MΩ
NTC Detection Level		170	220	300	mV

AC Characteristics

LED Current rise time	10% / 90% criterion, PWM rising (Note 6)	1	2.5	7.5	μsec
LED Current fall time	90% / 10% criterion, PWM falling (Note 6)	1	2.5	7.5	μsec
Propagation Delay PWM rising to I _{outB/T}	50% criterion (Note 6)	-	5	15	μsec
Propagation Delay PWM falling to I _{outB/T}	50% criterion (Note 6)	-	5	15	μsec
PWM Propagation Delay Delta	(Falling time) - (Rising time)	-		4	μsec
Delay Time VS to BASE	VS rising through UVLO to BASE going high through 0.5 V C _{BASE} = 50 pF, R _{BASE} = 680 Ω PWM = VS, SC = floating, FB = GND, NTC = GND	-	4	9	μsec
Open Load Blanking Delay	FLTS capacitor charge time not included	25	42	70	μsec
Short Circuit Blanking Time		10	23	36	μsec
Power-Up Blanking Time		10	23	36	μsec

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Designed to meet these characteristics over the stated voltage and temperature recommended operating ranges, though may not be 100% parametrically tested in production.
4. Guaranteed by design.
5. NTC = 400 mV is > NTC detection level and is a higher impedance than when operating within the detection level.
6. Evaluated at VS = 14V, (LED string current)_{max} = 15 mA to 37 mA.
7. Device tested at 18 V. Upper limit of 6 V applies across the VS input supply range, but the maximum rating for FLTS (-0.3V to VS to -0.3V) must be considered for all system designs especially at the minimum extreme of VS = 4.5 V.

TYPICAL PERFORMANCE CHARACTERISTICS

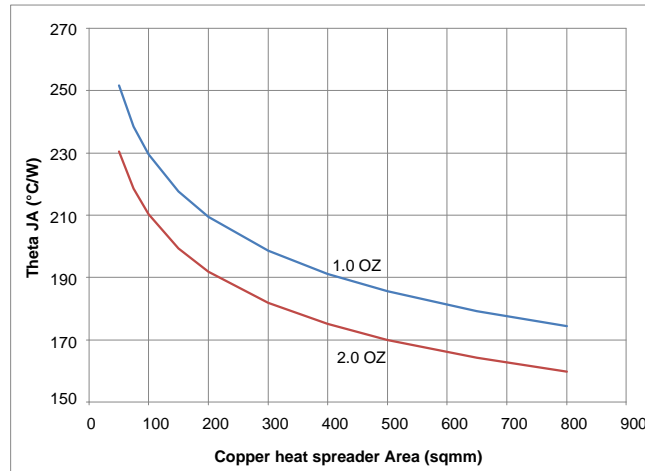


Figure 4. θ_{JA} vs. Copper Spreader Area

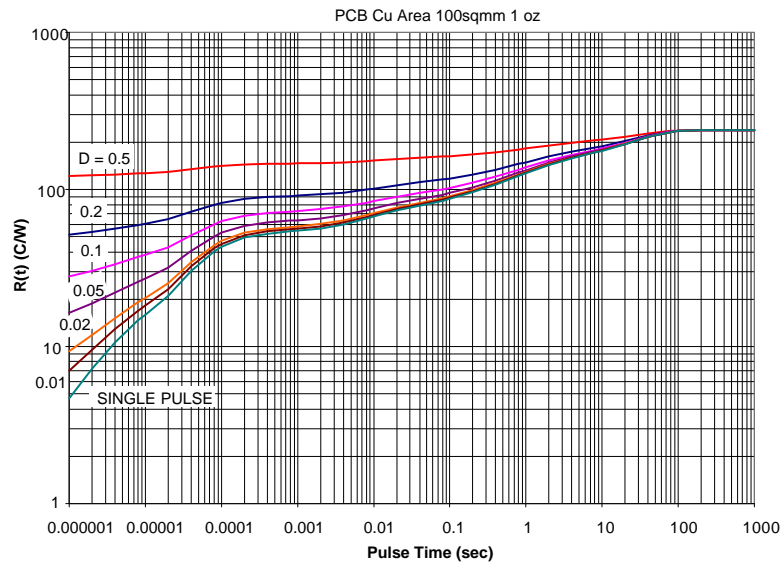


Figure 5. Thermal Duty Cycle Curves on 650 mm² Spreader Test Board

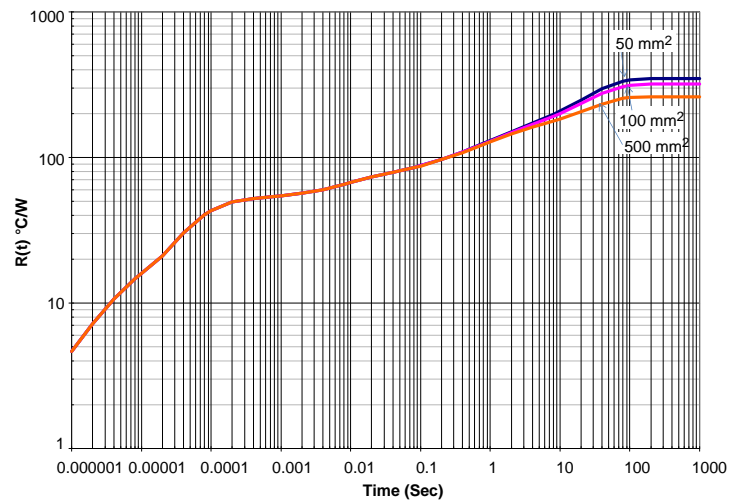


Figure 6. Single Pulse Heating Curve

Detailed Operating Description

The NCV7691 device provides low-side current drive via an external bipolar transistor. The low voltage (152 mV) current sense threshold allows for maximum dropout voltage in the system. Dimming is performed using the dedicated PWM pin on the IC. Average output current is directly related to the intensity of the LED (or LED string).

Output Drive

Figure 7 shows the typical output drive configuration. A feedback loop regulates the current through the external LED. U1 monitors the voltage across the external sense resistor (R1). When the voltage exceeds the 152 mV reference, the output of U1 goes from high to low sending a signal the buffer (U2) decreasing the base drive to the external transistor (BCP56). For loads above 150 mA, a PZT651 device (replacing the BCP56) is recommended for stable operation.

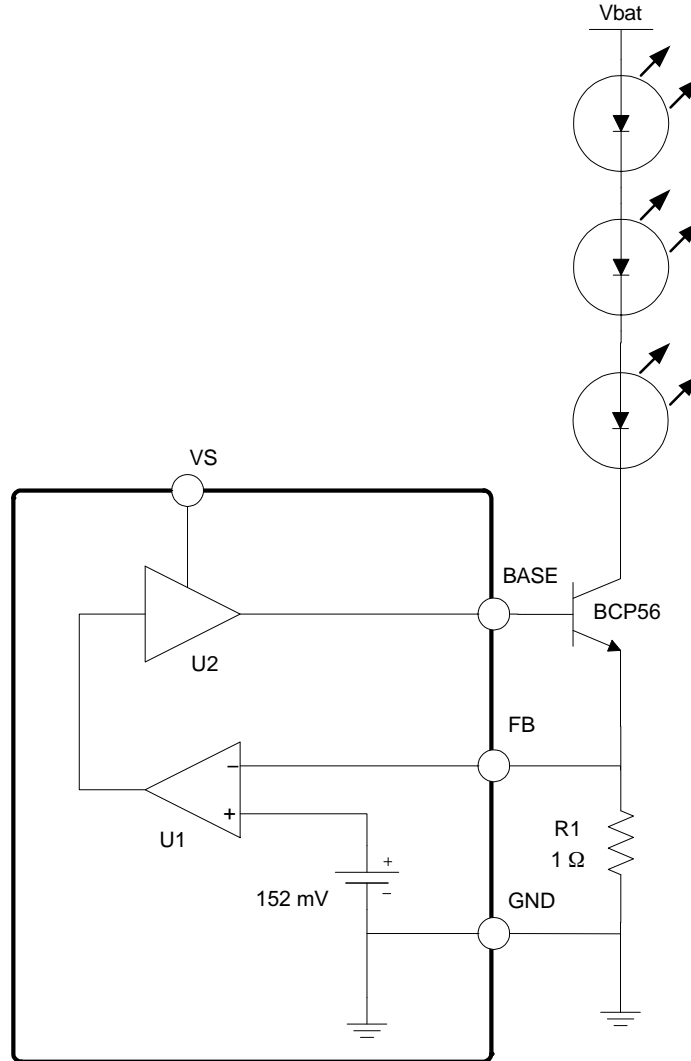


Figure 7. Output Drive Configuration

FLTS Reporting

FLTS reports three fault conditions (by going high) all of which force the output off.

- Open Circuit (latched)
- Thermal Shutdown (thermal hysteresis)
- Short Circuit (latched)

Latched off conditions can be reinitiated by a toggle of the PWM pin or a power down of the supply (VS).

Open Load Detection

Faulted output strings due to open load conditions sometimes require the complete shutdown of illumination within an automotive rear lighting system. The NCV7691 provides that feature option. When an open load is detected, the output turns off, and can be turned back on again by a toggle of the PWM pin or a power down of the supply (VS). If the open load feature is not used, FLTS should be tied to GND. Grounding FLTS disables open load detection. Short circuit detection and thermal shutdown functions remain active but are not reported externally. The BASE pin is actively held low in this case.

System Voltage and Overvoltage Fold-back

Low voltage system operation is typically limited by head room in the LED string. Because of this limitation, detection of open loads is inactive below VS = typ 8.5 V (Open Load Disable voltage). There is also an upper limitation. The current roll off feature of the part resets the loop at a lower reference voltage and consequential lower current for VS above the Overvoltage Fold-back threshold on VS, (typ 19.5 V). The open load Detection circuitry is inactive for VS above this Overvoltage Fold-back threshold voltage.

Open Load Timing

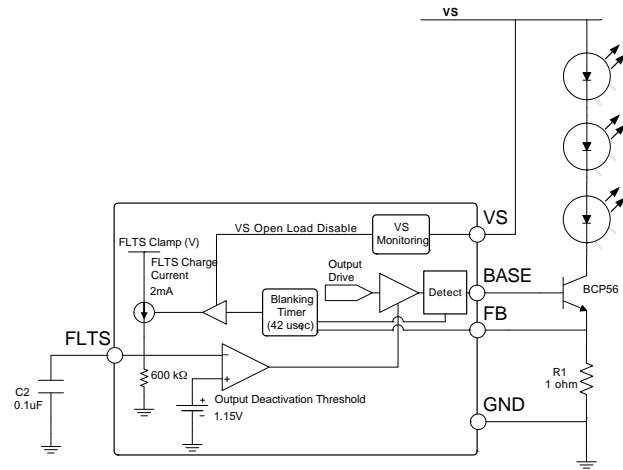
The timing for open load detection is programmed using the FLTS pin. The NCV7691 device regulates a 152 mV reference point (Figure 8 on the feedback pin (FB)). When the voltage decreases (half of the FB Regulation Voltage) or the base current reaches the internal 25 mA (typ) limit for 42 μ s the timer associated with the FLTS pin starts by charging the capacitor with a 2 mA current source. When the voltage on FLTS exceeds the output Deactivation Threshold (1.15 V (typ)), the BASE pin is pulled low and is held low by an internal pulldown resistor.

A 42 μ sec blanking time during power up ensures there is enough time for power-up to eliminate false open-load detections. The slow FLTS discharge (600 k Ω [typ]) load (and resultant long time to restart LED drive) eliminates flickering effects.

FLTS Interface

Figure 9 shows an open-drain logic level FET serving as a buffer to the microprocessor.

Figure 10 shows the proper wired "OR" connection for applications which require all channels to latch-off with an open load condition. An open load condition will be reported back to the microprocessor regardless of which channel it occurs on. Note the NCV7691 device uses a feature which allows any channel to charge the FLTS capacitor due to its definition at a charge current value much higher than the discharge value (2 mA versus 600 k Ω [typ]). Additional NCV7691 Single Current Controller devices device may share the same common FLTS capacitors in systems requiring multiple ICs.



Open load can be disabled by connecting FLTS to GND.

Figure 8. Open Load Detection Circuitry

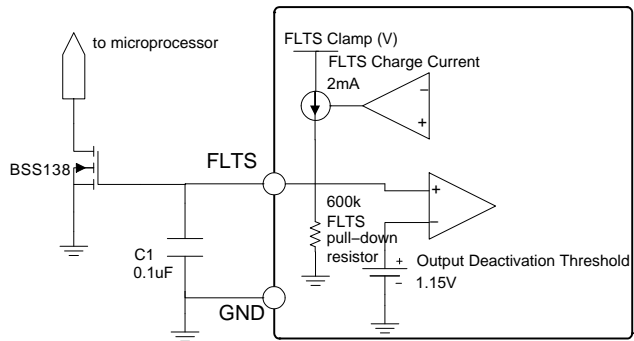
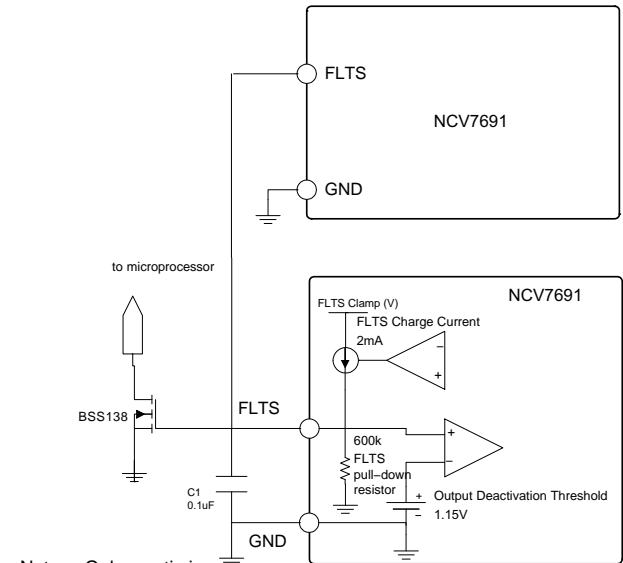


Figure 9. Open Drain Output Interface to Microprocessor



Note – Only one timing capacitor and interface transistor are required for system operation.

Figure 10. FLTS Wired OR to Microprocessor

Table 1. OPEN LOAD DETECTION

Open Load (VS > Open Load Disable Threshold)	FLTS	BASE
No Open Load	(with FLTS capacitor) Normal Operation (held low)	regulation
No Open Load	Grounded	regulation
FB = 1/2 regulation	(with FLTS capacitor) FLTS starts charging	Held low via internal pull-down resistor after time-out.
BASE Current > 25 mA [typ]	(with FLTS capacitor) FLTS starts charging	Held low via internal pull-down resistor after time-out.
FB = 1/2 regulation	Grounded	Actively held low.
BASE Current > 25 mA [typ]	Grounded	Actively held low.

Temperature Compensation

The NCV7691 device typically operates with a zero TC output current source. The NTC (Negative Temperature Coefficient) pin provides an alternative for an output current which degrades with temperature as defined by the designer's external components.

Zero TC operation is provided when the NTC pin is connected to GND. When a negative temperature coefficient output current is desired to compensate for effects of external LED illumination, the setup shown in Figure 11 will provide the function. On the NTC pin, a comparator detects when the voltage is higher than typ 220 mV, and this voltage is used to provide the feedback reference voltage for the current feedback regulation loop.

The zener provides a reference voltage for the negative temperature coefficient NTC device through an external divider. Be careful of your choice of the zener diode as the

temperature coefficients of the devices have a wide variation with the low voltage zeners having a high negative temperature coefficient and the high voltage zeners having a positive temperature coefficient. The regulation loop voltage on NTC should be sufficiently higher than the 220 mV reference voltage to avoid interactions. A typical regulation voltage of 1.6 V is suggested.

The overall tolerance specification for the NTC functionality is broken down into two components.

1. Absolute error. A $\pm 2\%$ tolerance is attributed to the expected value as a result of internal circuitry (most predominantly the 1/10 resistor divider).
2. Reference error. A $\pm 7\text{mV}$ offset mismatch in the circuitry referenced to FB.

This provides a part capability of $(V(\text{NTC})/10) \times 0.98 - 7\text{mV} < V(\text{FB}) < (V(\text{NTC})/10) \times 1.02 + 7\text{mV}$.

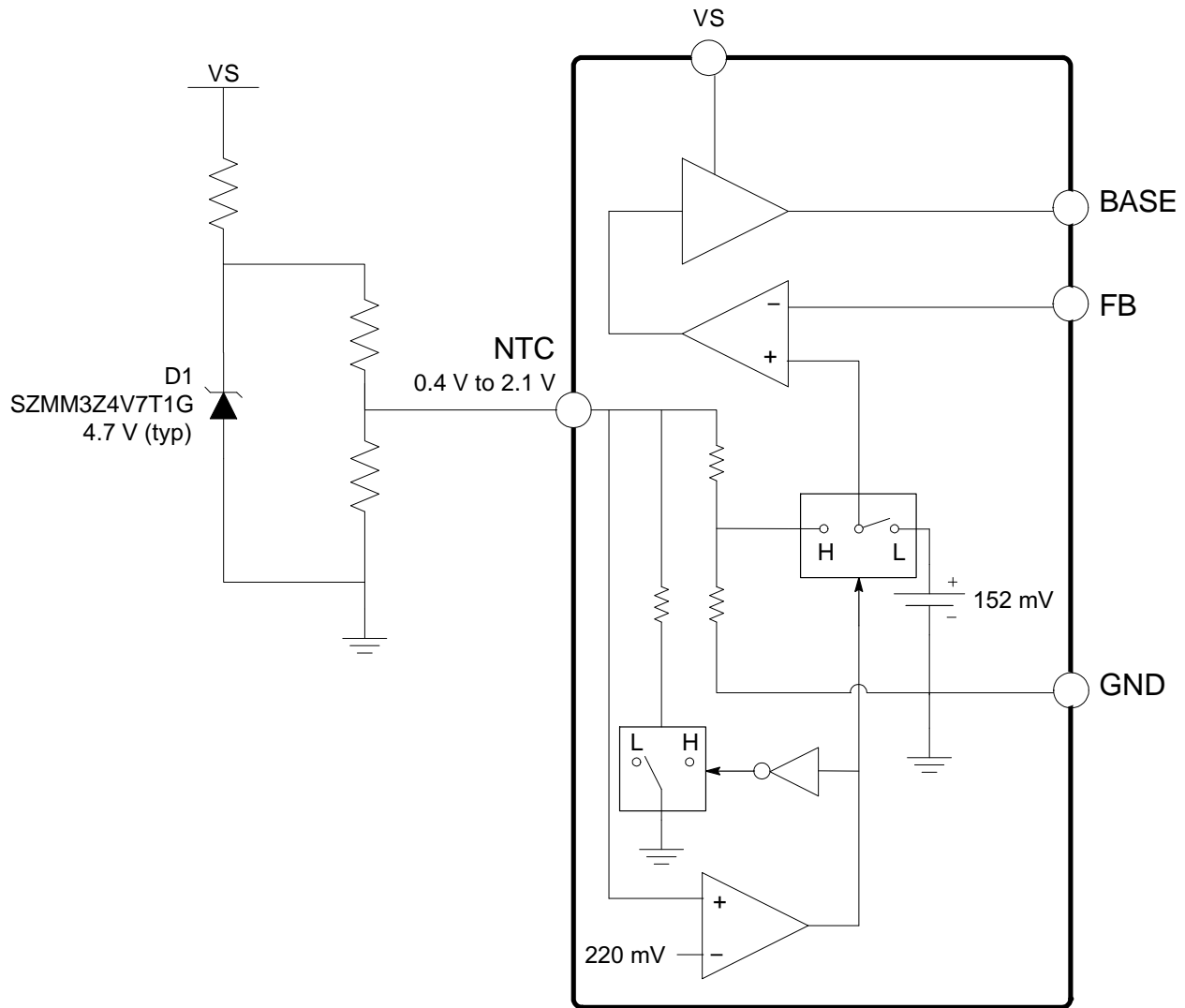


Figure 11. Negative Temperature Compensation Operation

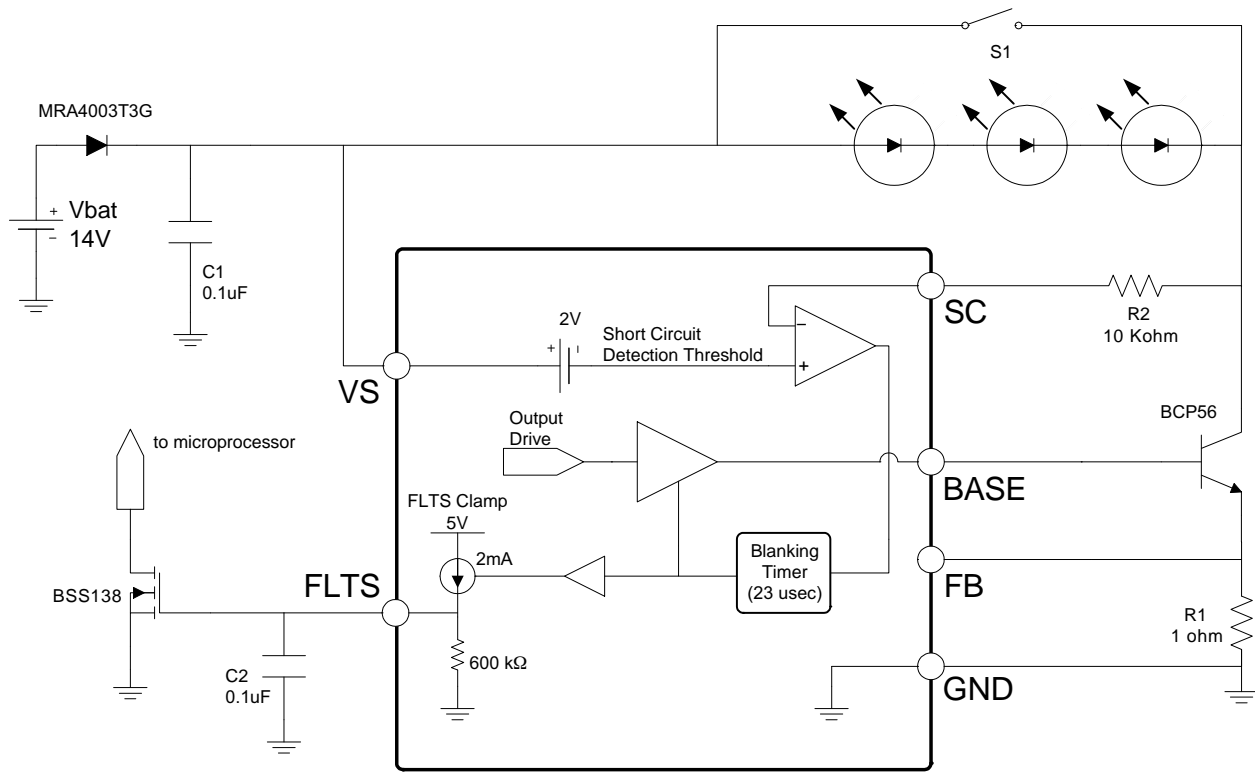
Short Circuit Detection

The short circuit (SC) pin of the device is used as an input to detect a fault when the collector of the external bipolar transistor is shorted to the battery voltage. The threshold voltage detection is referenced 2.0 volts down from the VS pin. A voltage of less than 2.0 volts between VS and SC will latch the device off. The PWM pin must be toggled or UVLO event must occur to reinitiate a turn-on. The detection time for this event is swift to protect the external transistor. To maintain operation during transient events down to 4.5 V, the short circuit detection circuitry is inactive below VS = typ 8.5 V. (the same Open Load Disable voltage as used to disable Open load detection). Otherwise false short circuit events could be falsely triggered due to non-conduction of the external LEDs during transients. Figure 12 shows a short circuit event modeled as a switch

(S1). The comparator connected between VS and SC is referenced to a voltage 2.0 V down from VS. A detection voltage less than 2.0 V will toggle a signal from the comparator to the output drive buffer turning off output drive (BASE) to the external bipolar transistor. An initial blanking time of 23 μ sec is used during turn-on of the device to ignore false detections. This is beneficial during normal operation and when the device is used without a microprocessor input (PWM) interface as in Figure 12.

Switching off the Base-driver in case of SC, will also make the FLTS charge active, indicating the error to the microprocessor.

When having multiple channels an isolation might be needed to provide the appropriate voltage back to the SC pin during short circuit. Figure 13 shows how external diodes can provide this feature.



Short Circuit Detection is disabled below 8.5 V (typ).

Figure 12. Short Circuit Detection

Short Circuit Detection with 4 or more Channels

Interfacing the short circuit detection for multiple channels with one NCV7691 driver system is done easily using diodes or a diode resistor combination depending on your system requirements.

Figure 13 shows the implementation using 4 individual diodes which will work for all applications.

Figure 14 shows an implementation which will work provided the drop across the loads is < 3.4 V. This limitation is due to the SC minimum specification of $V_S - 1.7$ V. This setup saves the user 2 diodes.

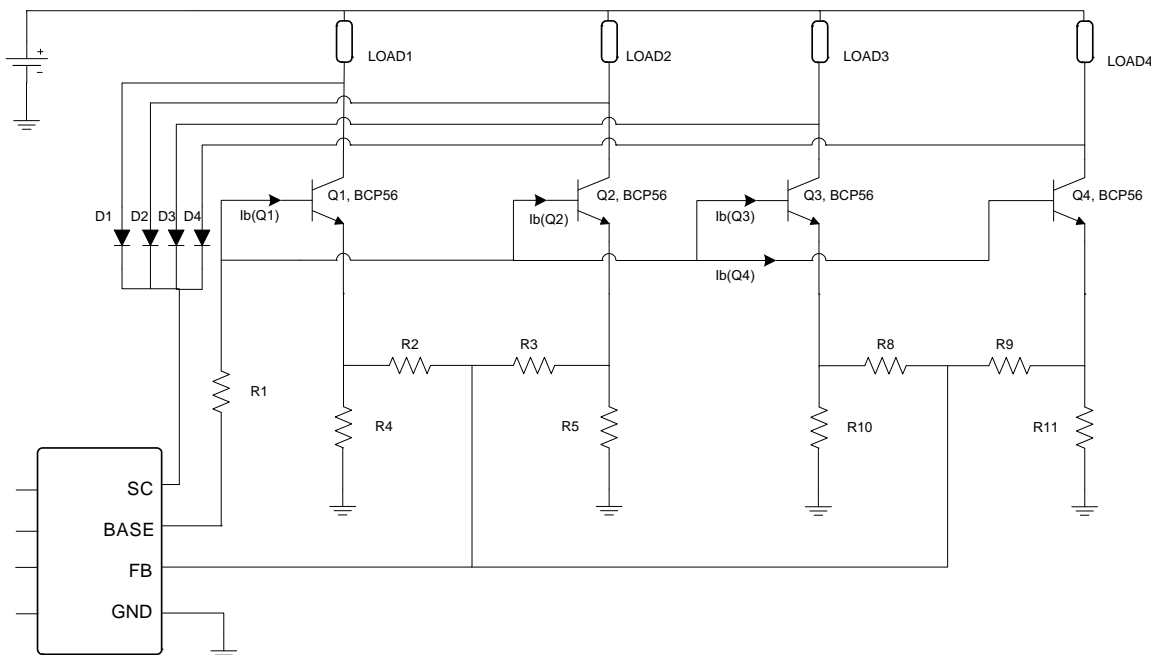


Figure 13. Short Circuit Detection with 4 or more Channels

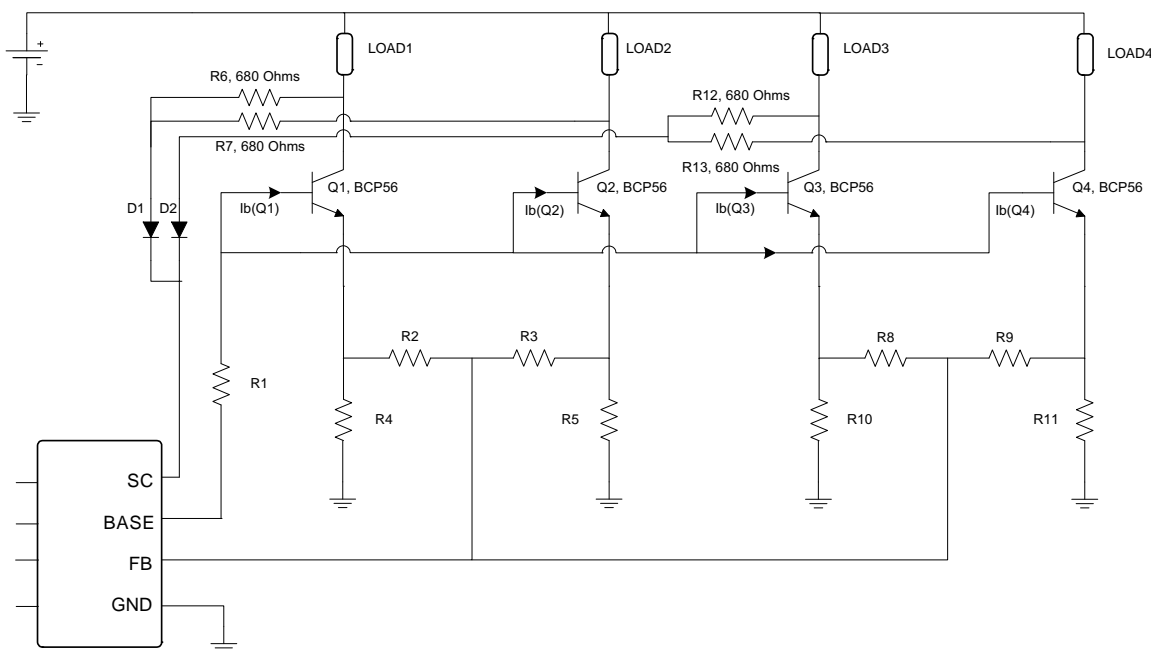


Figure 14. Saving Two Diodes for Short Circuit Protection

Thermal ShutDown

The thermal shut down circuit checks the internal junction temperature of the device. When the internal temperature rises above the Thermal shutdown threshold for greater than the thermal shutdown filter time (25 μ sec [typ]) the device is switched off. The filter is implemented to achieve a clean detection.

Switching off the Base-driver in case of TSD, will also make the FLTS charge active, indicating the error to the microprocessor.

Applications

Direct Drive without direct battery connection:

Some applications may not allow for a direct connection of VS to the battery voltage. These applications require a connection with a smart-FET. Figure 15 highlights this setup.

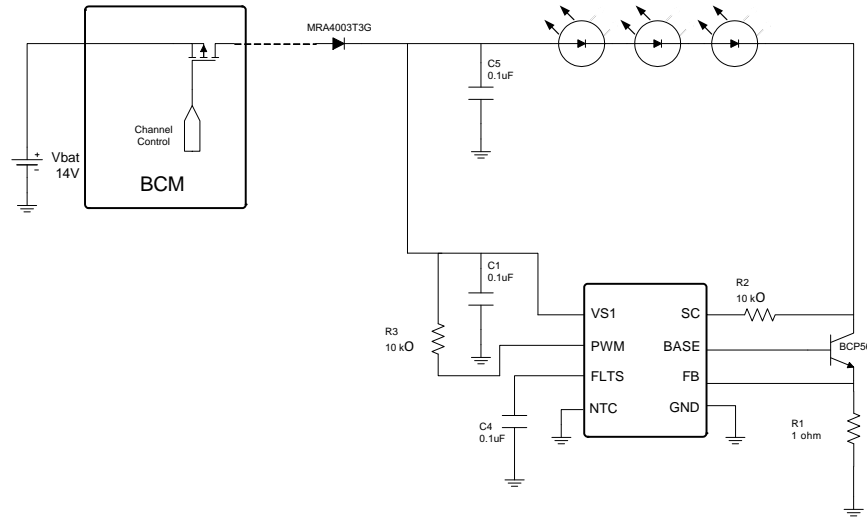


Figure 15. SmartFET Control

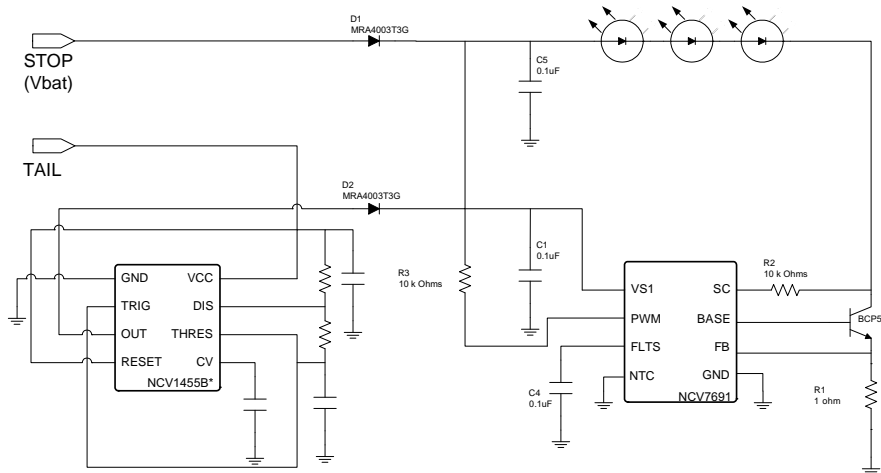


Figure 16. Stoplight / Taillight Application

Stoplight / Tail Light Application

Automotive applications have a need to drive the RCL (Rear Combination Light). Combining the NCV7691 with the NCV1455B device accomplishes that task. Figure 16 shows the interface of the two ICs using an additional diode (D2). The STOP input signal provides a signal to the NCV7691 which will provide a 100% duty cycle output to the LED strings whenever STOP is high. When only TAIL is high, a modulated duty cycle input is provided to the PWM input and also provides power to the NCV7691 and the LED string. The NCV1455B can provide up to 200 mA (albeit with a 2.5 V drop at 200 mA) of output drive current.

If your application exceeds the current capability of the NCV1455B (200mA) two extra diodes will be required as shown in Figure 17. In this case, the current flow through the LEDs will come from STOP and/or TAIL eliminating the high current from the NCV1455B.

NCV7691

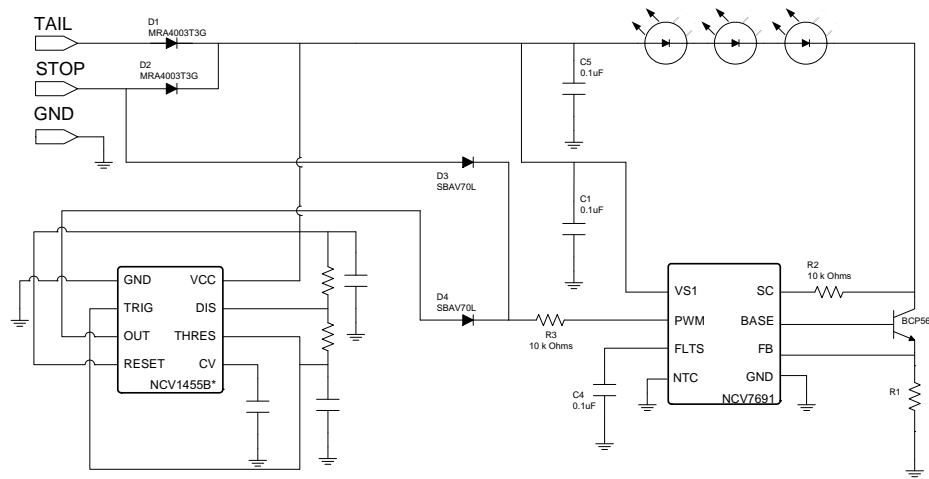


Figure 17. Stoplight / Taillight Application at higher currents

Figure 18: Application Diagram with no microprocessor. A resistor pull-up from PWM to VS illustrates how the device can be used as a standalone LED driver without using a microprocessor to drive the PWM input.

Figure 19 along with Figure 20 and Figure 21 highlight the use of the NCV7691 device with multiple strings connected to a common drive BASE pin and using external resistors to tie additional strings to a common feedback point (FB). The FB pin will maintain regulation with the FB pin at 152 mV.

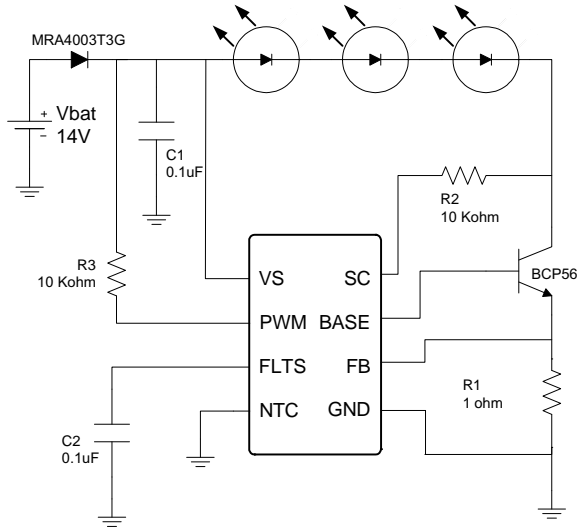
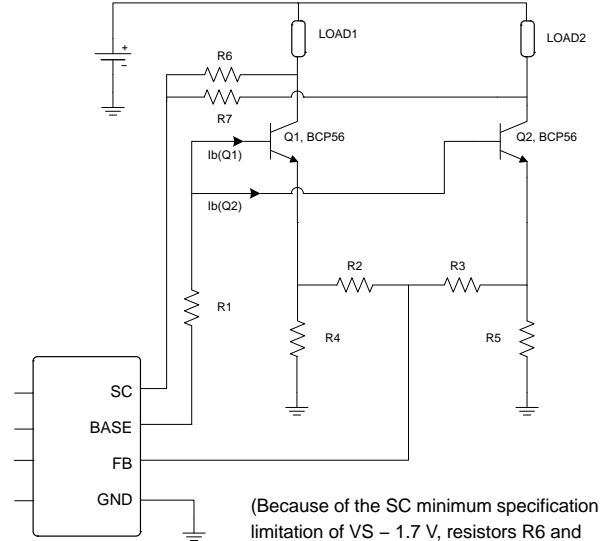


Figure 18. Application Diagram with No Microprocessor

R1 is used to limit current in the event of an open circuit on one of the strings.

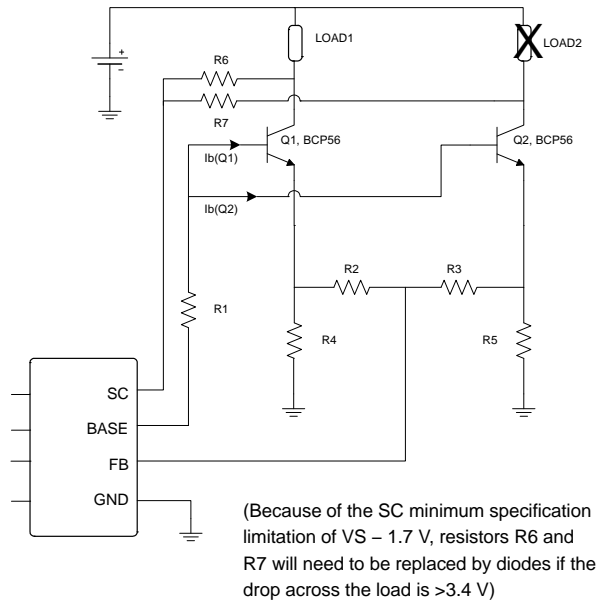
Figure 20: Open Circuit.

It shows the change in BASE drive which occurs with an open circuit in one of the strings. The drive current out of BASE changes from $(I_b(Q1) + I_b(Q2))$ to $(I_b(Q1) + I_c(Q2))$ as regulation will try to maintain in the loop to get 152 mV on FB. Figure 21 shows the equivalent circuit when an open load occurs.



(Because of the SC minimum specification limitation of VS – 1.7 V, resistors R6 and R7 will need to be replaced by diodes if the drop across the load is >3.4 V)

Figure 19. Driving Multiple Strings



(Because of the SC minimum specification limitation of VS – 1.7 V, resistors R6 and R7 will need to be replaced by diodes if the drop across the load is >3.4 V)

Figure 20. Open Circuit

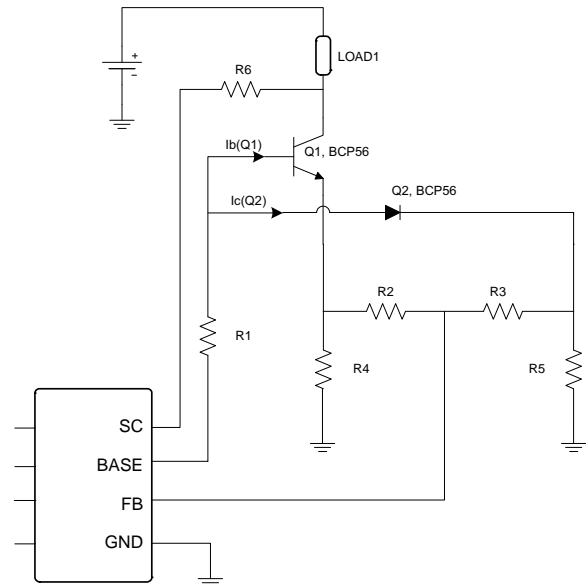


Figure 21. Open Circuit Equivalent

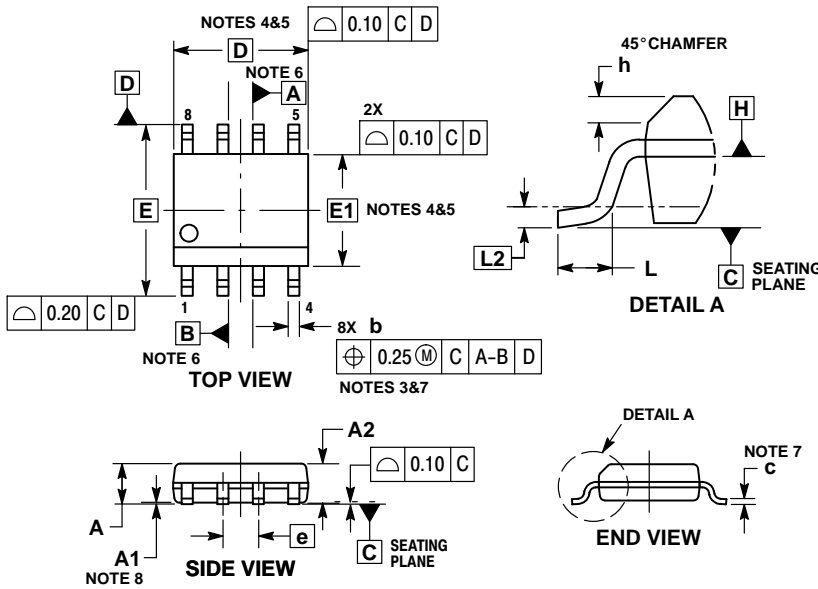
Table 2. FAULT HANDLING TABLE

Fault	Fault Memory	Sense Condition	Driver Condition During Fault	Driver Condition after Parameters Within Specified Limits	Output Fault Clear or Operation Restitution Requirement	Fault Reporting
Open Load (FLTS active)	Latched off.	42 μ sec w / FB < Vref/2 76 mV or I _{base} > 25 mA 8.5 V < VS < 19.5 V	Driver is latched Off.	Driver is latched Off.	Toggle PWM pin. VS power down below UVLO.	FLTS low to high
Open Load (FLTS = GND)	No effect.	n/a	No effect.	No effect.	n/a	n/a
Short Circuit to Vbat (FLTS active)	Latched off.	23 μ sec SC < VS – 2 V VS > 8.5 V	Driver is latched Off.	Driver is latched Off.	Toggle PWM pin. VS power down below UVLO.	FLTS low to high
Short Circuit to Vbat (FLTS = GND)	Latched off.	23 μ sec SC < VS – 2 V VS > 8.5 V	Driver is latched Off.	Driver is latched Off.	Toggle PWM pin. VS power down below UVLO.	FLTS low to high
Under Voltage Lockout	Driver Off	VS < 4 V	Driver Off	Driver back on.	VS > 4 V minus 200mV hysteresis.	n/a
Over Voltage	Output Current Reduced	Threshold 1 VS > 19.5 V Threshold 2 VS > 31 V	Reduced output current (FB Regulation Voltage)	Driver back to normal operation.	VS < threshold minuse 700 mV hysteresis.	n/a
Thermal Shutdown (FLTS active)	Driver Off	23 μ sec T _J > 170°C	Driver Off	Driver back on.	Die temperature below shutdown hysteresis	FLTS low to high
Thermal Shutdown (FLTS =GND)	Driver Off	23 μ sec T _J > 170°C	Driver Off	Driver back on.	Die temperature below shutdown hysteresis	FLTS low to high

NOTE: All specified voltages, currents, and times refer to typical numbers.

PACKAGE DIMENSIONS

SOIC 8
CASE 751AZ
ISSUE B

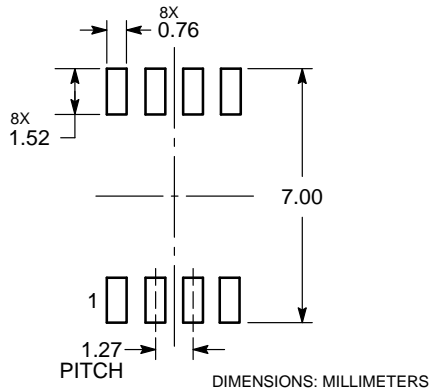


NOTES:


1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.004 mm IN EXCESS OF MAXIMUM MATERIAL CONDITION.
4. DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.006 mm PER SIDE. DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.010 mm PER SIDE.
5. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM. DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTER-MOST EXTREMES OF THE PLASTIC BODY AT DATUM H.
6. DIMENSIONS A AND B ARE TO BE DETERMINED AT DATUM H.
7. DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 TO 0.25 FROM THE LEAD TIP.
8. A1 IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

DIM	MILLIMETERS	
	MIN	MAX
A	---	1.75
A1	0.10	0.25
A2	1.25	---
b	0.31	0.51
c	0.10	0.25
D	4.90 BSC	
E	6.00 BSC	
E1	3.90 BSC	
e	1.27 BSC	
h	0.25	0.41
L	0.40	1.27
L2	0.25 BSC	

RECOMMENDED
SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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